

AO6420 60V N-Channel MOSFET

General Description

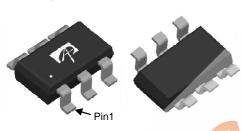
The AO6420 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications.

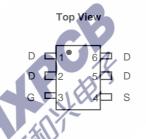
Product Summary

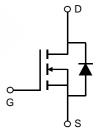
$$\begin{split} &V_{DS}\left(V\right) = 60V \\ &I_{D} = 4.2A \; (V_{GS} = 10V) \\ &R_{DS(ON)} < 60m\Omega \; (V_{GS} = 10V) \\ &R_{DS(ON)} < 75m\Omega \; (V_{GS} = 4.5V) \end{split}$$











Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Drain	T _A =25℃		4.2		
Current A,F	T _A =70℃	I _D	3.4	A	
Pulsed Drain Current B		I _{DM}	20		
	T _A =25℃	Р	2.00	W	
Power Dissipation	T _A =70℃	$-P_{D}$	1.28	VV	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	C	

Thermal Characteristics								
Parameter		Symbol	Тур	Typ Max l				
Maximum Junction-to-Ambient A	t ≤ 10s	Ь	48	62.5	€\M			
Maximum Junction-to-Ambient A	Steady-State	$R_{\theta JA}$	74	110	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	35	40	℃/W			

N Channel Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter Conditions		Min	Тур	Max	Units				
STATIC PARAMETERS										
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu A, V_{GS}=0V$	60			V				
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =60V, V _{GS} =0V			1	μА				
		T _J =55℃			5	μιτ				
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V			100	nA				
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$	1	2.3	3	V				
$I_{D(ON)}$	On state drain current	V_{GS} =10V, V_{DS} =5V	20			Α				
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =4.2A		50	60	mΩ				
		T _J =125℃		85						
		V_{GS} =4.5V, I_D =3A		60	75	mΩ				
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =4.2A		13		S				
V_{SD}	Diode Forward Voltage	$I_S=1A, V_{GS}=0V$		0.78	1	V				
I_S	Maximum Body-Diode Continuous Current				3	Α				
DYNAMIC	PARAMETERS									
C _{iss}	Input Capacitance			450	540	pF				
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =30V, f=1MHz		60		pF				
C _{rss}	Reverse Transfer Capacitance			25		pF				
R_g	Gate resistance	$V_{GS}=0V$, $V_{DS}=0V$, $f=1MHz$		1.65	2	Ω				
SWITCHII	NG PARAMETERS									
Q _g (10V)	Total Gate Charge			9.5	11.5	nC				
Q _g (4.5V)	Total Gate Charge	V = 10V V = 30V I = 4.2A		4.3	5.5	nC				
Q_{gs}	Gate Source Charge	-V _{GS} =10V, V _{DS} =30V, I _D =4.2A		1.6		nC				
Q_{gd}	Gate Drain Charge			2.2		nC				
t _{D(on)}	Turn-On DelayTime			5.1	7	ns				
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =30V, R_L =7 Ω ,		2.6	4	ns				
$t_{D(off)}$	Turn-Off DelayTime	$R_{GEN}=3\Omega$		15.9	20	ns				
t _f	Turn-Off Fall Time]		2	3	ns				
t _{rr}	Body Diode Reverse Recovery Time	I _F =4.2A, dl/dt=100A/μs		25.1	35	ns				
Q _{rr}	Body Diode Reverse Recovery Charge I _F =4.2A, dI/dt=100A/μs			28.7		nC				

A: The value of R _{e,IA} is measured with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with T _A=25° C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

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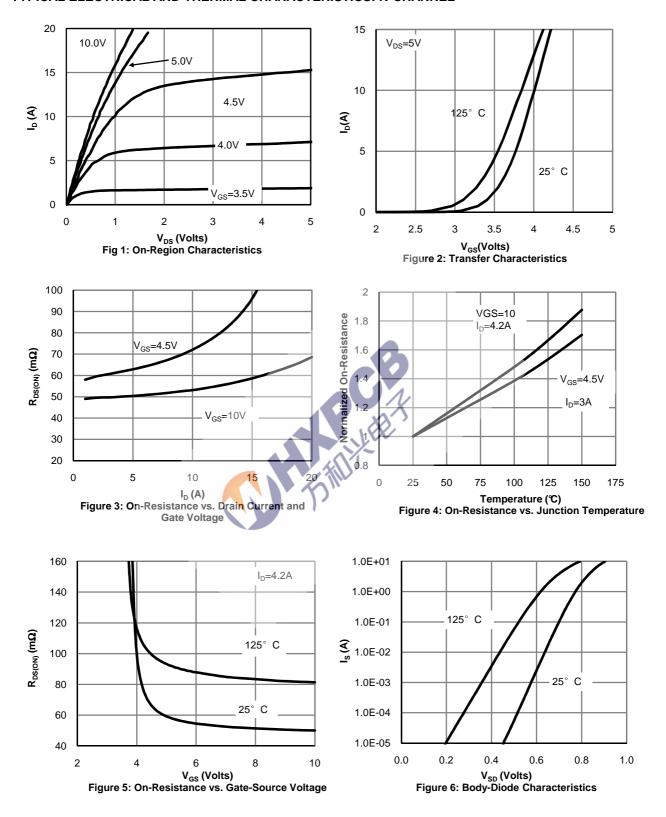
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

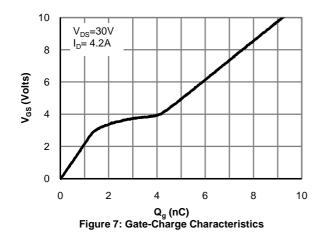
E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with T _A=25° C. The SOA curve provides a single pulse rating.

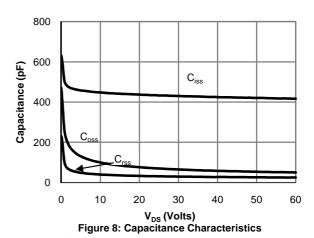
F.The current rating is based on the t \leq 10s thermal resistance rating.

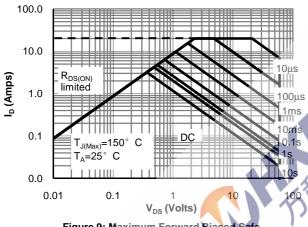
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS: N-CHANNEL



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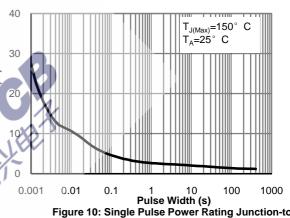


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

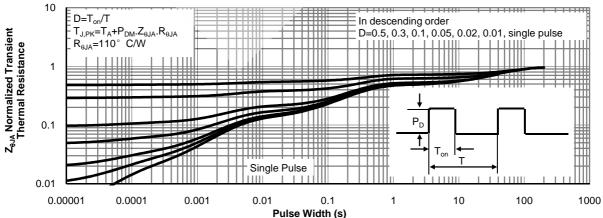


Figure 11: Normalized Maximum Transient Thermal Impedance